捷多邦,专业PCB打样工厂,24小时加急出货 查询BCR8PM-12LA-A8供应商 **IVENES** BCR8PM-12L Triac Medium Power Use REJ03G0303-0200 Rev.2.00 Nov.08.2004 **Features** • $I_{T(RMS)}$: 8 A Insulated Type V_{DRM}: 600 V Planar Passivation Type I_{FGTI} , I_{RGTI} , I_{RGTII} : 30 mA (20 mA)^{Note5} UL Recognized : Yellow Card No. E223904 WWW.DZSC.COM Viso : 2000 V File No. E80271 Outline TO-220F 1. T₁ Terminal 2. T₂ Terminal 3. Gate Terminal 2 З

Applications

Switching mode power supply, light dimmer, electronic flasher unit, control of household equipment such as TV sets, stereo systems, refrigerator, washing machine, infrared kotatsu, and carpet, solenoid driver, small motor control, copying machine, electric tool, electric heater control, and other general purpose control applications

Maximum Ratings

Peremeter	Symbol	Voltage class	L Insit	
Parameter	Symbol	12	– Unit	
Repetitive peak off-state voltage ^{Note1}	V _{DRM}	600	V	
Non-repetitive peak off-state voltage ^{Note1}	V _{DSM}	720	V	



BCR8PM-12L

Parameter	Symbol	Ratings	Unit	Conditions	
RMS on-state current	I _{T (RMS)}	8	A	Commercial frequency, sine full wave 360° conduction, Tc = 88°C	
Surge on-state current	I _{TSM}	80	A	60Hz sinewave 1 full cycle, peak value, non-repetitive	
I ² t for fusing	l ² t	26	A ² s	Value corresponding to 1 cycle of half wave 60Hz, surge on-state current	
Peak gate power dissipation	P _{GM}	5	W		
Average gate power dissipation	P _{G (AV)}	0.5	W		
Peak gate voltage	V _{GM}	10	V		
Peak gate current	I _{GM}	2	Α		
Junction temperature	Tj	- 40 to +125	°C		
Storage temperature	Tstg	- 40 to +125	°C		
Mass	—	2.0	g	Typical value	
Isolation voltage	Viso	2000	V	Ta = 25°C, AC 1 minute, T ₁ ·T ₂ ·G terminal to case	

Notes: 1. Gate open.

Electrical Characteristics

Parameter		Symbol	Min.	Тур.	Max.	Unit	Test conditions
Repetitive peak off-state current		I _{DRM}	_	—	2.0	mA	Tj = 125°C, V _{DRM} applied
On-state voltage		V _{TM}	_	—	1.6	V	$Tc = 25^{\circ}C$, $I_{TM} = 12 A$, Instantaneous measurement
Gate trigger voltage ^{Note2}	Ι	V_{FGTI}		_	1.5	V	$Tj = 25^{\circ}C, V_D = 6 V, R_L = 6 \Omega,$
	II	V _{RGTI}	_	—	1.5	V	$R_G = 330 \Omega$
	III	V _{RGTIII}	—	—	1.5	V	
Gate trigger current ^{Note2}	Ι	I _{FGTI}	_	—	30 ^{Note5}	mA	$Tj = 25^{\circ}C, V_D = 6 V, R_L = 6 \Omega,$
	II	I _{RGTI}	—	—	30 ^{Note5}	mA	$R_G = 330 \Omega$
	III	I _{RGTIII}	_	—	30 ^{Note5}	mA	
Gate non-trigger voltage		V_{GD}	0.2	—	—	V	$Tj = 125^{\circ}C, V_D = 1/2 V_{DRM}$
Thermal resistance		R _{th (j-c)}	_	—	3.7	°C/W	Junction to case ^{Note3}
Critical-rate of rise of off-state commutating voltage ^{Note4}		(dv/dt)c	10	—	—	V/µs	Tj = 125°C

Notes: 2. Measurement using the gate trigger characteristics measurement circuit.

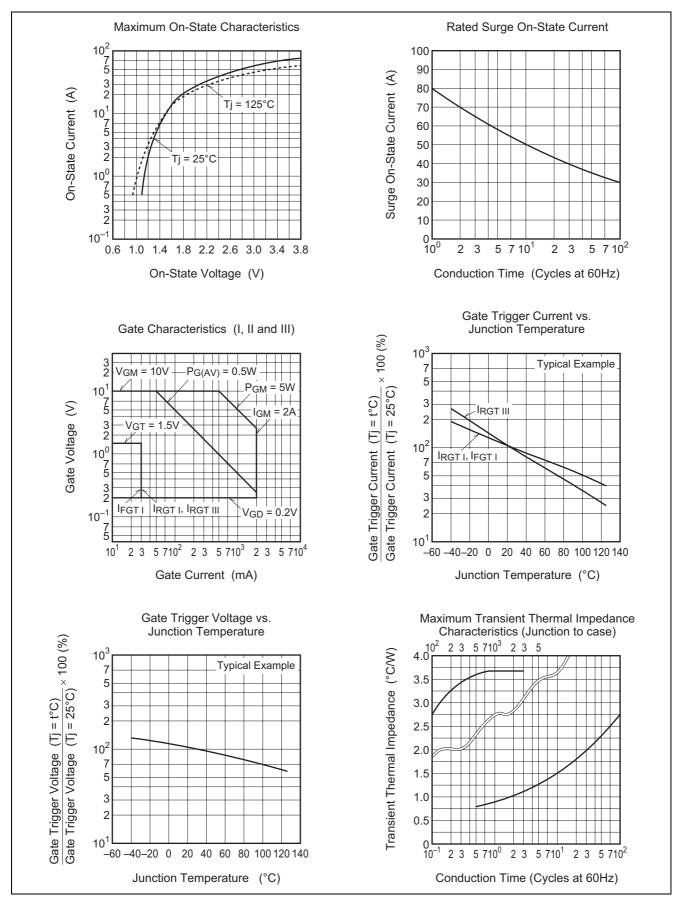
3. The contact thermal resistance $R_{th (c-f)}$ in case of greasing is 0.5°C/W.

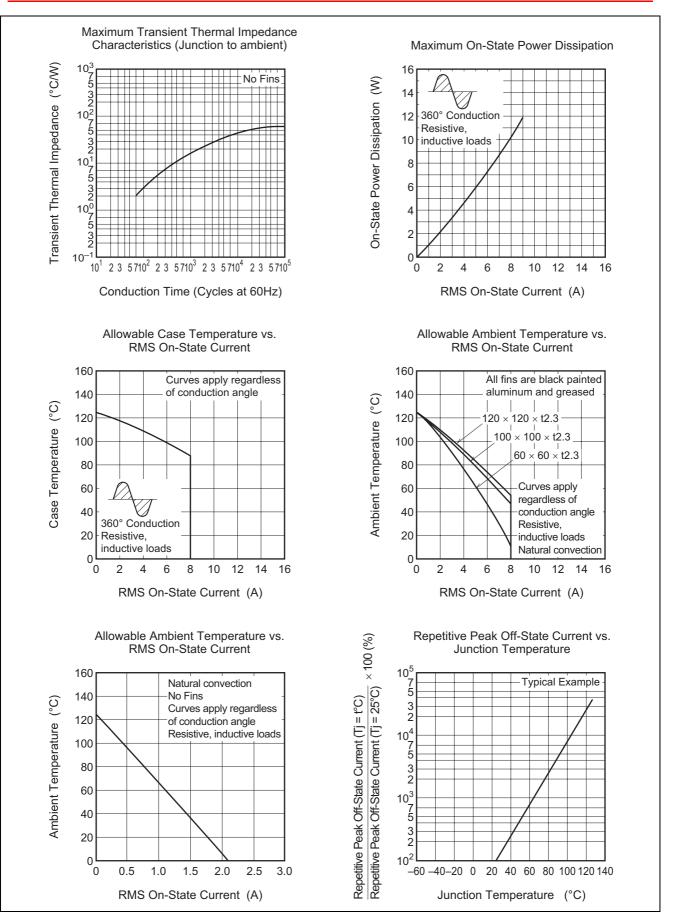
4. Test conditions of the critical-rate of rise of off-state commutating voltage is shown in the table below.

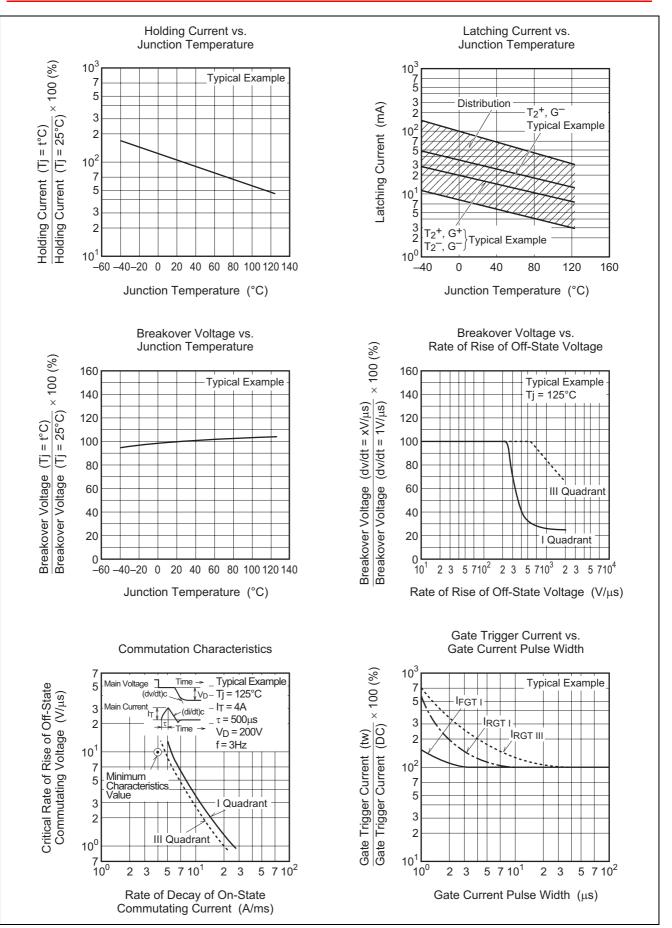
5. High sensitivity ($I_{GT} \le 20$ mA) is also available. (I_{GT} item: 1)

Test conditions	Commutating voltage and current waveforms (inductive load)
1. Junction temperature Tj = 125°C	Supply Voltage → Time
 Rate of decay of on-state commutating current (di/dt)c = - 4.0 A/ms 	Main Current → Time
3. Peak off-state voltage V _D = 400 V	Main Voltage Time (dv/dt)c V _D

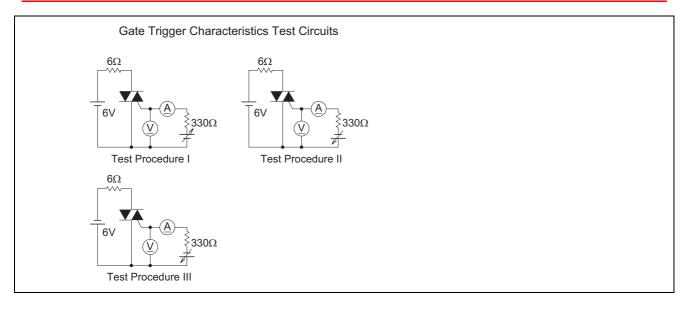
Performance Curves





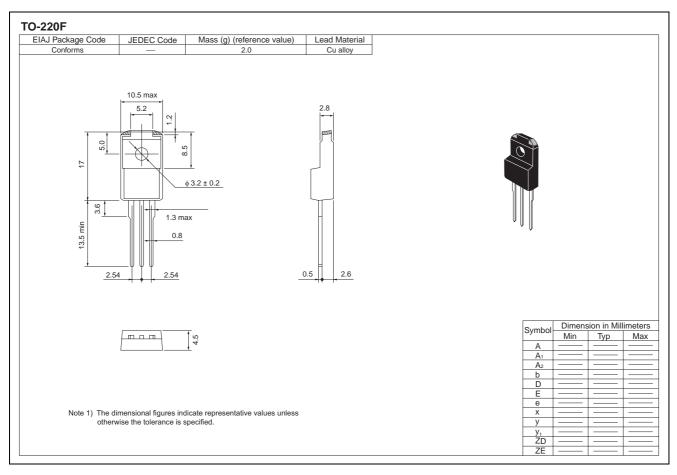


BCR8PM-12L



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Package Dimensions



Order Code

Lead form	Standard packing	Quantity	Standard order code	Standard order code example		
Straight type	Vinyl sack	100	Type name +A	BCR8PM-12LA		
Lead form	Plastic Magazine (Tube)	50	Type name +A – Lead forming code	BCR8PM-12LA-A8		
Note - Disease confirm the encoding chevit the chinging in detail						

Note : Please confirm the specification about the shipping in detail.

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